

Application No.: 09/436,158  
Attorney Docket: AMKOR-019RCE

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant:	Perez et al.	)	Confirmation No.	6214
		)		
Serial No.:	09/436,158	)	Art Unit:	2814
		)		
Filed:	11/09/1999	)	Examiner:	Ha, Nathan
		)		W.
For:	Semiconductor Package With Exposed	)		
	Die Pad and Body-Locking Lead	)		
	Frame	)		

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**AMENDMENT UNDER 37 C.F.R. 1.111**

Mail Stop Non-Fee Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir/Madam:

Responsive to the Office Action of June 24, 2003, the period for response extending until September 24, 2003, reconsideration of this action and allowance of all the claims of the present application are respectfully requested in view of the following amendments and remarks. The Examiner is respectfully requested to amend the specification and claims as follows:

*Amendments to the Claims* begin on page 2 of this paper; and

*Remarks* begin on page 7 of this paper.